

Programmable Unijunction Transistors

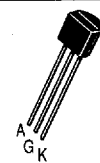
Silicon Programmable Unijunction Transistors

... designed to enable the engineer to "program" unijunction characteristics such as R_{BB} , η , I_V , and I_P by merely selecting two resistor values. Application includes thyristor-trigger, oscillator, pulse and timing circuits. These devices may also be used in special thyristor applications due to the availability of an anode gate. Supplied in an inexpensive TO-92 plastic package for high-volume requirements, this package is readily adaptable for use in automatic insertion equipment.

- Programmable — R_{BB} , η , I_V and I_P .
- Low On-State Voltage — 1.5 Volts Maximum @ $I_F = 50$ mA
- Low Gate to Anode Leakage Current — 10 nA Maximum
- High Peak Output Voltage — 11 Volts Typical
- Low Offset Voltage — 0.35 Volt Typical ($R_G = 10$ k ohms)

2N6027
2N6028

PUTs
40 VOLTS
300 mW



CASE 29-04
(TO-226AA)
STYLE 16

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted.)

Rating	Symbol	Value	Unit
*Power Dissipation Derate Above 25°C	P_F $1/\theta_{JA}$	300 4	mW mW/ $^\circ\text{C}$
*DC Forward Anode Current Derate Above 25°C	I_T	150 2.67	mA mA/ $^\circ\text{C}$
*DC Gate Current	I_G	± 50	mA
Repetitive Peak Forward Current 100 μs Pulse Width, 1% Duty Cycle *20 μs Pulse Width, 1% Duty Cycle	I_{TRM}	1 2	Amps
Non-repetitive Peak Forward Current 10 μs Pulse Width	I_{TSM}	5	Amps
*Gate to Cathode Forward Voltage	V_{GKF}	40	Volts
*Gate to Cathode Reverse Voltage	V_{GKR}	-5	Volts
*Gate to Anode Reverse Voltage	V_{GAR}	40	Volts
*Anode to Cathode Voltage ⁽¹⁾	V_{AK}	± 40	Volts
Operating Junction Temperature Range	T_J	-50 to +100	$^\circ\text{C}$
*Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$

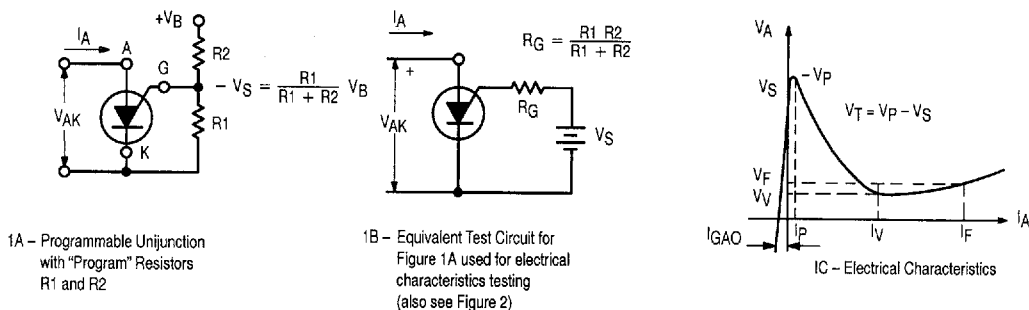
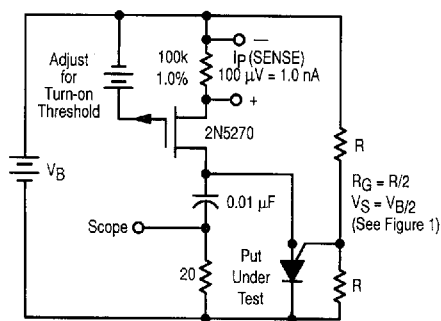
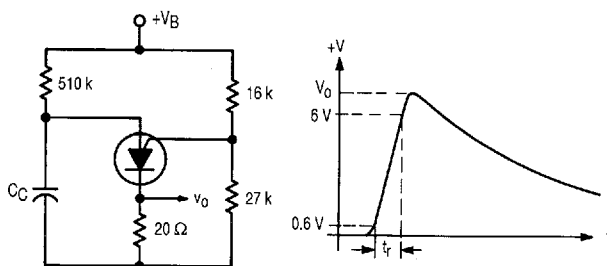
*Indicates JEDEC Registered Data

1. Anode positive, $R_{GA} = 1000$ ohms
Anode negative, $R_{GA} = \text{open}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Fig. No.	Symbol	Min	Typ	Max	Unit
*Peak Current ($V_S = 10\text{ Vdc}$, $R_G = 1\text{ M}\Omega$) ($V_S = 10\text{ Vdc}$, $R_G = 10\text{ k ohms}$)	2,9,11	I_P	— — — —	1.25 0.08 4 0.70	2 0.15 5 1	μA
*Offset Voltage ($V_S = 10\text{ Vdc}$, $R_G = 1\text{ M}\Omega$) ($V_S = 10\text{ Vdc}$, $R_G = 10\text{ k ohms}$)	1	V_T	0.2 0.2 0.2	0.70 0.50 0.35	1.6 0.6 0.6	Volts
*Valley Current ($V_S = 10\text{ Vdc}$, $R_G = 1\text{ M}\Omega$) ($V_S = 10\text{ Vdc}$, $R_G = 10\text{ k ohms}$) ($V_S = 10\text{ Vdc}$, $R_G = 200\text{ ohms}$)	1,4,5	I_V	— — 70 25 1.5 1	18 18 150 150 — —	50 25 — — — —	μA mA
*Gate to Anode Leakage Current ($V_S = 40\text{ Vdc}$, $T_A = 25^\circ\text{C}$, Cathode Open) ($V_S = 40\text{ Vdc}$, $T_A = 75^\circ\text{C}$, Cathode Open)	—	I_{GAO}	— —	1 3	10 —	nAdc
Gate to Cathode Leakage Current ($V_S = 40\text{ Vdc}$, Anode to Cathode Shorted)	—	I_{GKS}	—	5	50	nAdc
*Forward Voltage ($I_F = 50\text{ mA Peak}$)	1,6	V_F	—	0.8	1.5	Volts
*Peak Output Voltage ($V_G = 20\text{ Vdc}$, $C_C = 0.2\text{ }\mu\text{F}$)	3,7	V_O	6	11	—	Volt
Pulse Voltage Rise Time ($V_B = 20\text{ Vdc}$, $C_C = 0.2\text{ }\mu\text{F}$)	3	t_r	—	40	80	ns

*Indicates JEDEC Registered Data.

FIGURE 1 – ELECTRICAL CHARACTERIZATION

FIGURE 2 – PEAK CURRENT (I_P) TEST CIRCUIT

FIGURE 3 – V_O AND t_r TEST CIRCUIT


TYPICAL VALLEY CURRENT BEHAVIOR

FIGURE 4 – EFFECT OF SUPPLY VOLTAGE

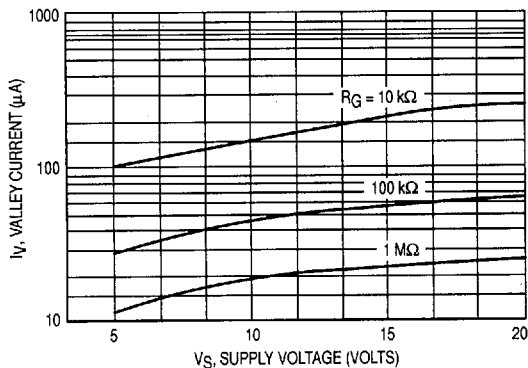


FIGURE 5 – EFFECT OF TEMPERATURE

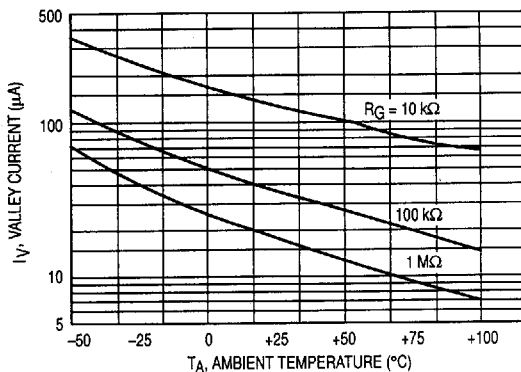


FIGURE 6 – FORWARD VOLTAGE

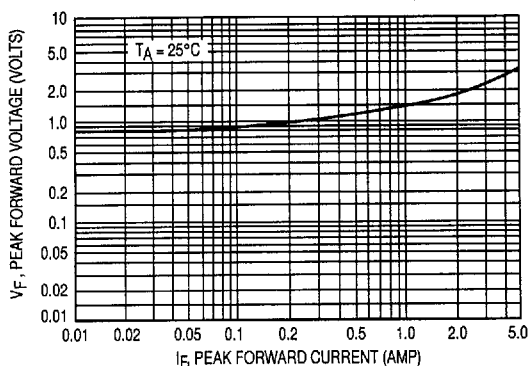


FIGURE 7 – PEAK OUTPUT VOLTAGE

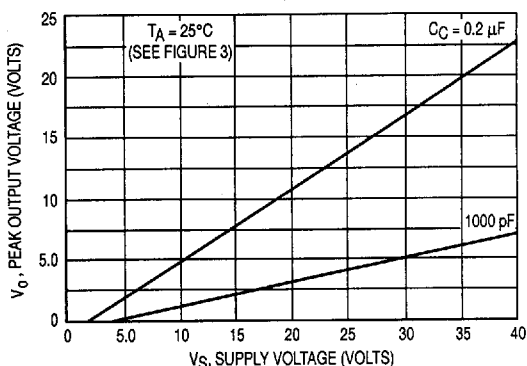
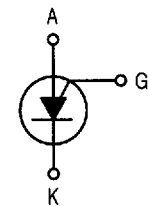
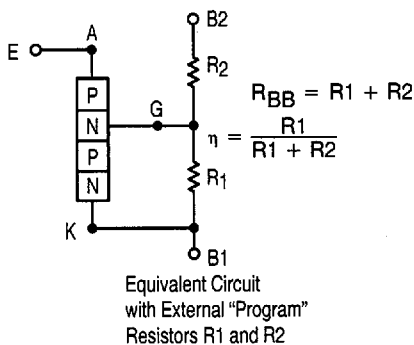


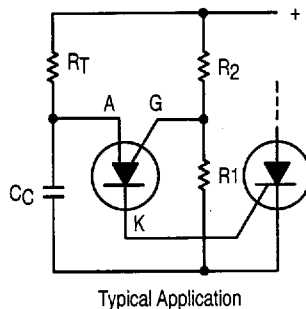
FIGURE 8
PROGRAMMABLE UNI-JUNCTION



Circuit Symbol



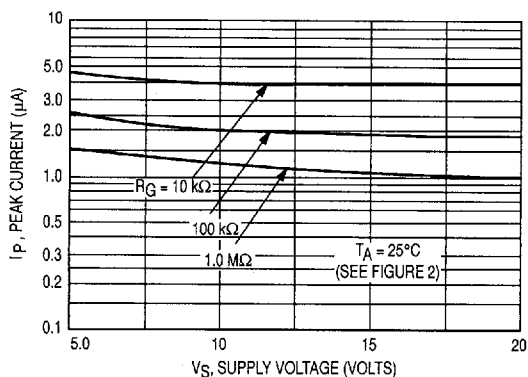
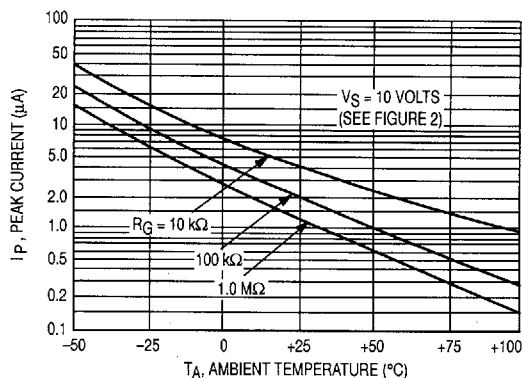
Equivalent Circuit
with External "Program"
Resistors R_1 and R_2



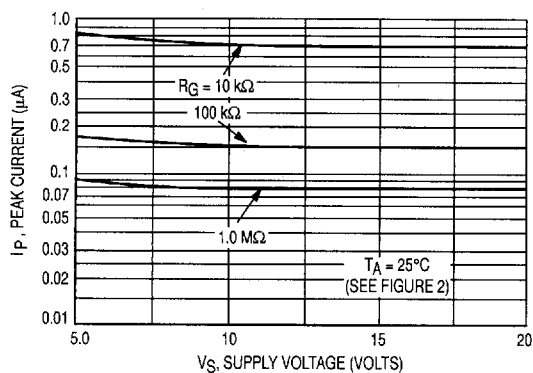
Typical Application

TYPICAL PEAK CURRENT BEHAVIOR

2N6027

FIGURE 9 – EFFECT OF SUPPLY VOLTAGE AND R_G FIGURE 10 – EFFECT OF TEMPERATURE AND R_G 

2N6028

FIGURE 11 – EFFECT OF SUPPLY VOLTAGE AND R_G FIGURE 12 – EFFECT OF TEMPERATURE AND R_G 